|  |  |  |
| --- | --- | --- |
| C:\Users\ba\AppData\Local\Microsoft\Windows\Temporary Internet Files\Content.IE5\R9YC35I5\LG-0001-OHB_02_Logo OHB AG.jpg | **MIP REPORT** | Date: 29.03.2016 |
| **SO-CAU-OHB–RP-50** | | |
| **1. INSPECTED UNIT** | | |
| Part number | --- | |
| Part name: | STEP-Analog | |
| Serial number | AD1 | |
|  |  | |
| **2. INSPECTION TYPE** | | |
| Type of inspection (solder, coating, final …) | solder / gluing | |
|  | **P**ass/ **F**ail/ **C**omments | |
| Connectors/Saver | Pass / NA | |
| Hardware assembly | C | |
| Gluing | Pass | |
| Soldering | Pass | |
| Cleanliness | Pass | |
| **3. RESULTS** | | |
| Part acceptable? | PCB accepted / zur weiteren Verarbeitung freigegeben | |
|  |  | |
| **4. COMMENTS** | | |
| Build due to Manufacturing Flow Chart: **STEP-Analog-Board-OHB-XI-11**  See WE SO-CAU-OHB-RP-47 | | |
| **5 SIGNATURE** | | |
| Inspection performed: M. Quack 29.03.2016  Name Date Signature | | |

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| **G:\DCIM\100NIKON\DSCN8330.JPG** |
| **G:\DCIM\100NIKON\DSCN8345.JPG** |

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| **G:\DCIM\100NIKON\DSCN8331.JPG** |
| **G:\DCIM\100NIKON\DSCN8332.JPG** |